



RF PATH:
 1. Components need as close as possible
 2. PCB is 4-layer FR4, RF path need to use 50 ohm impedance.

Test Pad description

TP1	RF_TP	TP7	BAT+
TP2	MIC+	TP8	BAT-
TP3	MIC-	TP9	TXD
TP4	SPK+	TP10	RXD
TP5	SPK-	TP11	ADP_IN
TP6	TEST	TP12	GND

Title		
Size	Number	Revision
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